

Complementary MOSFET

ELM35602KA-S

■ General Description

ELM35602KA-S uses advanced trench technology to provide excellent $R_{ds(on)}$ and low gate charge.

■ Features

N-channel	P-channel
$V_{ds}=30V$	$V_{ds}=-30V$
$I_d=8A$	$I_d=-6A$
$R_{ds(on)} < 25m\Omega$ ($V_{gs}=10V$)	$R_{ds(on)} < 45m\Omega$ ($V_{gs}=-10V$)
$R_{ds(on)} < 37m\Omega$ ($V_{gs}=4.5V$)	$R_{ds(on)} < 80m\Omega$ ($V_{gs}=-4.5V$)

■ Maximum Absolute Ratings

Parameter	Symbol	N-ch (Max.)	P-ch (Max.)	Unit	Note
Drain-source voltage	V_{ds}	30	-30	V	
Gate-source voltage	V_{gs}	± 20	± 20	V	
Continuous drain current	I_d	8.0	-6.0	A	
		6.5	-4.8		
Pulsed drain current	I_{dm}	50	-50	A	1
Power dissipation	P_d	3.0	3.0	W	
		2.1	2.1		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	-55 to 150	°C	

■ Thermal Characteristics

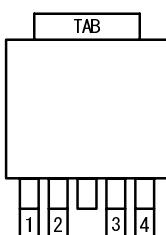
Parameter	Symbol	Device	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$R_{\theta ja}$	N-ch		42	°C/W	
Maximum junction-to-case	$R_{\theta jc}$	N-ch		6	°C/W	
Maximum junction-to-ambient	$R_{\theta ja}$	P-ch		42	°C/W	
Maximum junction-to-case	$R_{\theta jc}$	P-ch		6	°C/W	

1. Pulse width limited by maximum junction temperature.

2. Duty cycle $\leq 1\%$.

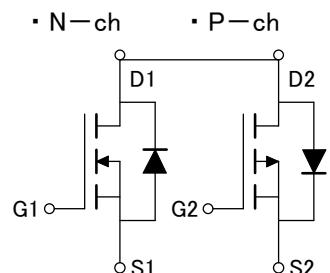
■ Pin Configuration

TO-252-4 (TOP VIEW)



Pin No.	Pin name
1	SOURCE1
2	GATE1
3	SOURCE2
4	GATE2
TAB	DRAIN1/DRAIN2

■ Circuit



Complementary MOSFET

ELM35602KA-S

■ Electrical Characteristics (N-ch)

T_a=25°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=250 μA, Vgs=0V	30			V	
Zero gate voltage drain current	Idss	Vds=24V, Vgs=0V			1	μA	
		Vds=20V, Vgs=0V, Tj=55°C			10		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			±100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250 μA	1.0	1.5	2.5	V	
On state drain current	Id(on)	Vgs=10V, Vds=5V	50			A	1
Static drain-source on-resistance	Rds(on)	Vgs=10V, Id=8A		18	25	mΩ	1
		Vgs=4.5V, Id=7A		25	37		
Forward transconductance	Gfs	Vds=10V, Id=8A			19	S	1
Diode forward voltage	Vsd	If=3A, Vgs=0V			1.3	V	1
DYNAMIC PARAMETERS							
Input capacitance	Ciss	Vgs=0V, Vds=10V, f=1MHz		790		pF	
Output capacitance	Coss			175		pF	
Reverse transfer capacitance	Crss			65		pF	
SWITCHING PARAMETERS							
Total gate charge	Qg	Vgs=10V, Vds=15V, Id=8A		16.0		nC	2
Gate-source charge	Qgs			2.5		nC	2
Gate-drain charge	Qgd			2.1		nC	2
Turn-on delay time	td(on)	Vgs=10V, Vds=10V, Id ≈ 1A Rgen=6 Ω		2.2	4.4	ns	2
Turn-on rise time	tr			7.5	15.0	ns	2
Turn-off delay time	td(off)			11.8	21.3	ns	2
Turn-off fall time	tf			3.7	7.4	ns	2
Body diode reverse recovery time	trr	If=8A, dl/dt=100A/μs		42		ns	
Body diode reverse recovery charge	Qrr			30		nC	

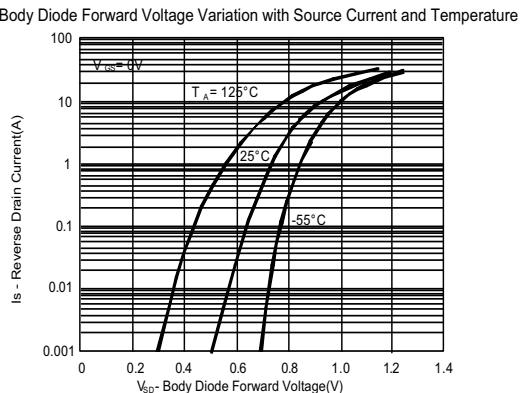
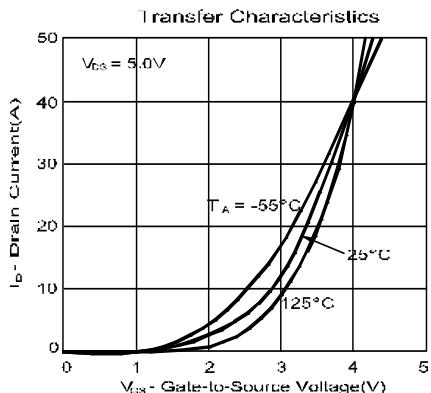
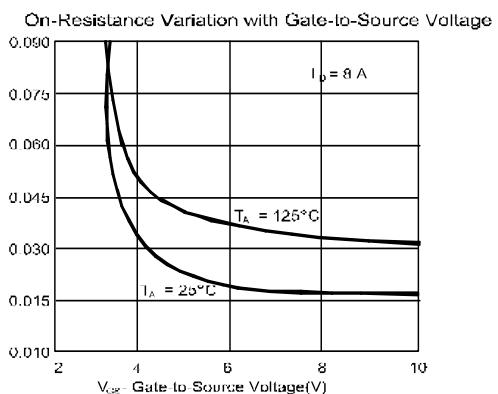
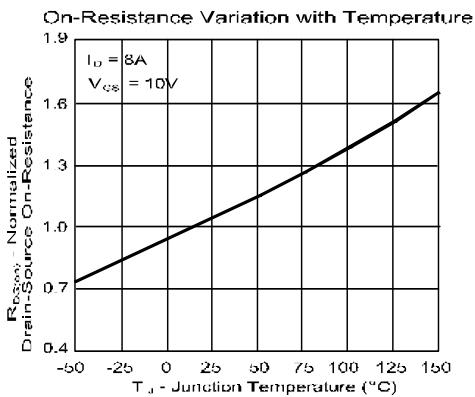
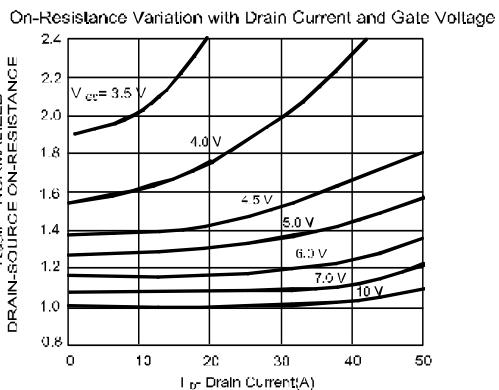
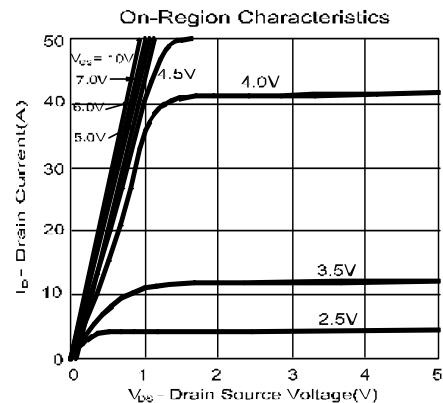
NOTE :

1. Pulse test : Pulse width ≤ 300 μsec, duty cycle ≤ 2%.
2. Independent of operating temperature.
3. Pulse width limited by maximum junction temperature.

Complementary MOSFET

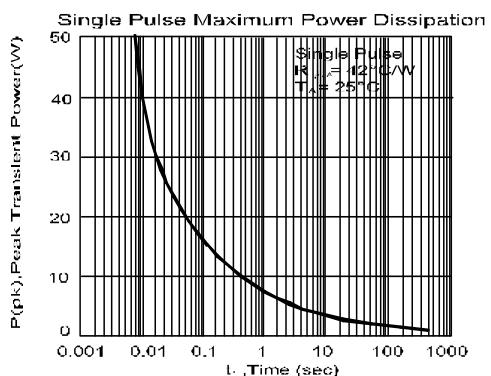
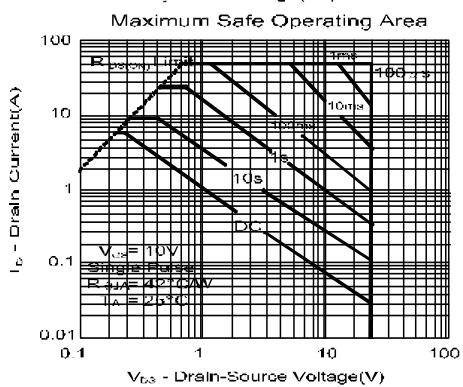
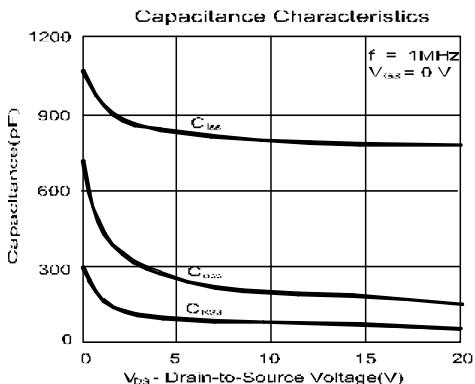
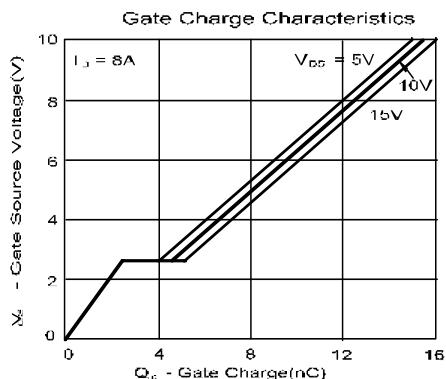
ELM35602KA-S

■ Typical Electrical and Thermal Characteristics (N-ch)



Complementary MOSFET

ELM35602KA-S



Complementary MOSFET

ELM35602KA-S

■ Electrical Characteristics (P-ch)

T_a=25°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=-250 μA, Vgs=0V	-30			V	
Zero gate voltage drain current	Idss	Vds=-24V, Vgs=0V			-1	μ A	
		Vds=-20V, Vgs=0V, Tj=55°C			-10		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			±100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250 μA	-1.0	-1.5	-2.5	V	
On state drain current	Id(on)	Vgs=-10V, Vds=-5V	-50			A	1
Static drain-source on-resistance	Rds(on)	Vgs=-10V, Id=-6A		34	45	m Ω	1
		Vgs=-4.5V, Id=-5A		58	80		
Forward transconductance	Gfs	Vds=-10V, Id=-6A		11		S	1
Diode forward voltage	Vsd	If=-3A, Vgs=0V			-1.3	V	1
DYNAMIC PARAMETERS							
Input capacitance	Ciss	Vgs=0V, Vds=-10V, f=1MHz		690		pF	
Output capacitance	Coss			310		pF	
Reverse transfer capacitance	Crss			75		pF	
SWITCHING PARAMETERS							
Total gate charge	Qg	Vgs=-10V, Vds=-15V Id=-6A		14.0		nC	2
Gate-source charge	Qgs			2.2		nC	2
Gate-drain charge	Qgd			1.9		nC	2
Turn-on delay time	td(on)	Vgs=-10V, Vds=-10V Id ≈ -1A, Rgen=6 Ω		6.7	13.4	ns	2
Turn-on rise time	tr			9.7	19.4	ns	2
Turn-off delay time	td(off)			19.8	35.6	ns	2
Turn-off fall time	tf			12.3	22.2	ns	2
Body diode reverse recovery time	trr	If=-6A, dl/dt=100A/μs		55		ns	
Body diode reverse recovery charge	Qrr			52		nC	

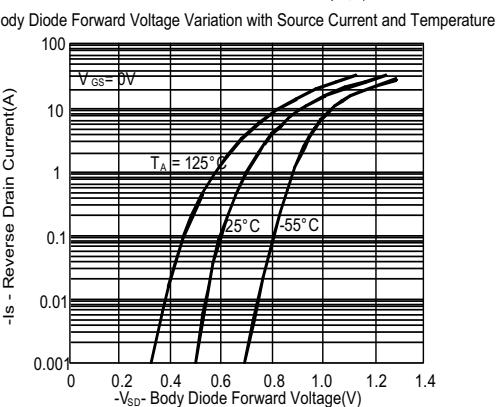
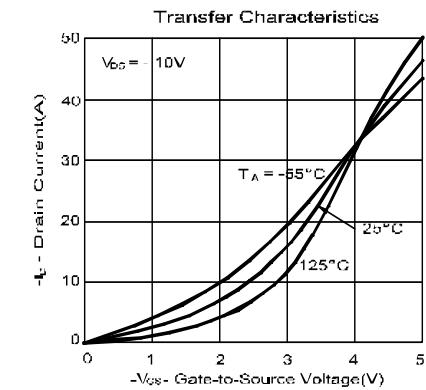
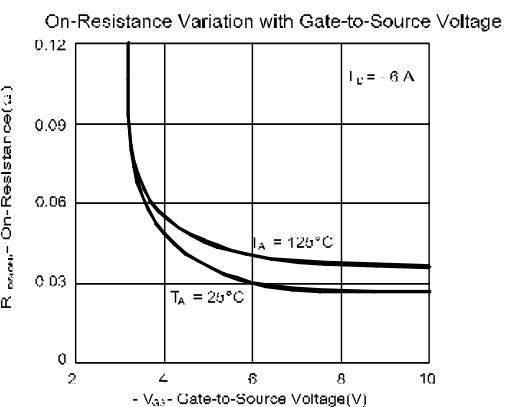
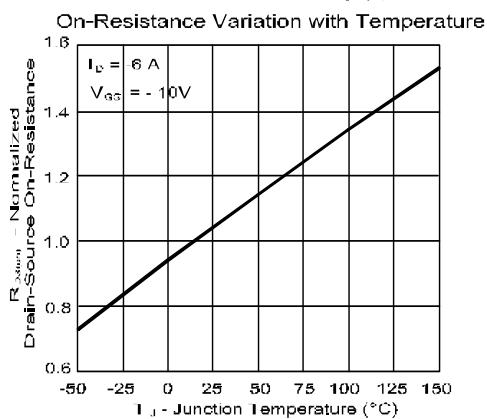
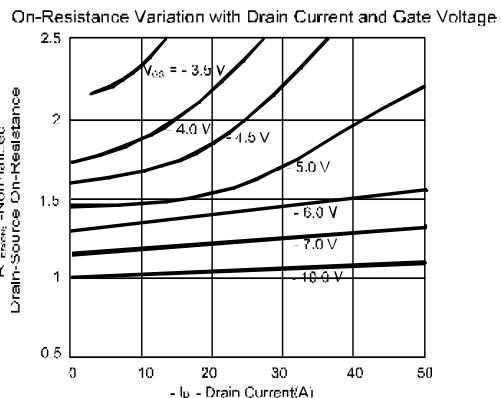
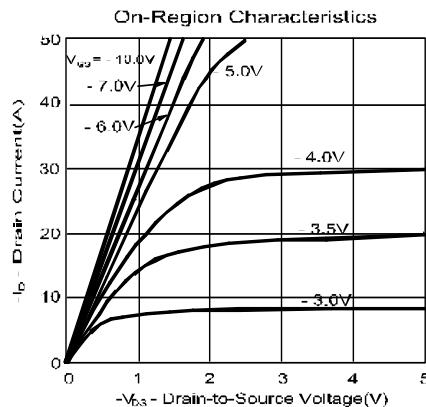
NOTE :

1. Pulse test : Pulse width ≤ 300 μsec, duty cycle ≤ 2%.
2. Independent of operating temperature.
3. Pulse width limited by maximum junction temperature.

Complementary MOSFET

ELM35602KA-S

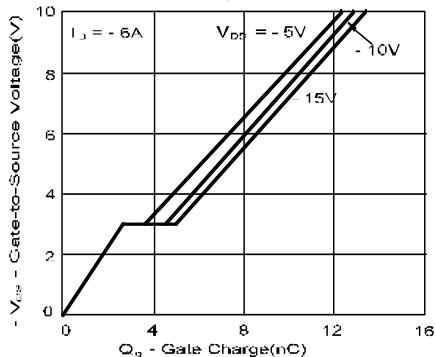
■ Typical Electrical and Thermal Characteristics (P-ch)



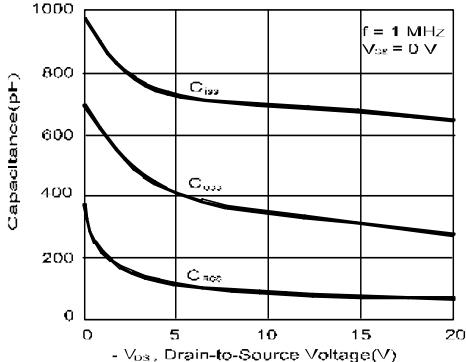
Complementary MOSFET

ELM35602KA-S

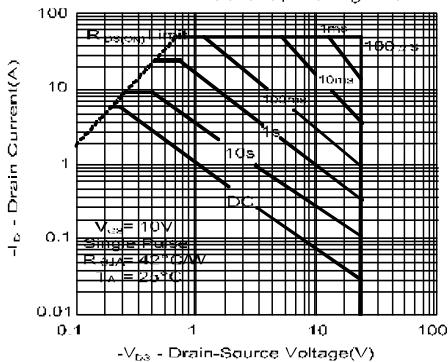
Gate Charge Characteristics



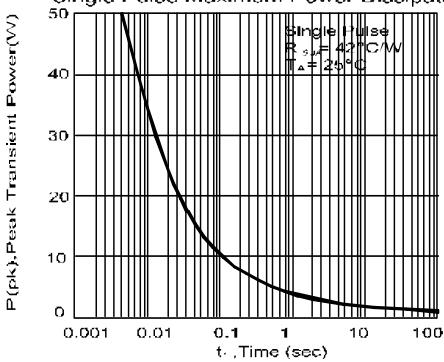
Capacitance Characteristics



Maximum Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

